



# Product Change Notification

**Change Notification #:** 114765- 00  
**Change Title:** Intel® Server Chassis P4308XXMHGC  
PCN 114765- 00, Label  
Update Regulatory and Safety Labels  
**Date of Publication:** July 13, 2016

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	July 28, 2016
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Chassis P4308XXMHGC:

1. Update the packaging regulatory label, with New Australia/New Zealand (RCM) Logo and the Safety Nemko Logo. Please see Figure-1 and Figure-2 below for details.



Figure-1: Pre-Change



Figure-2: Post-change

- Update the regulatory label with New Australia/New Zealand (RCM) Logo and the Safety Nemko Logo. Please see Figure-3 and Figure-4 below for details.



Figure-3: Pre-Change



Figure-4: Post-Change

**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

**Products Affected / Intel Ordering Codes:**

<b>Product Code</b>	<b>MM#</b>	<b>Pre Change TA</b>	<b>Post Change TA</b>
P4308XXMHGC	916320	G51267-004	G51267-005

**PCN Revision History:****Date of Revision:**

July 13, 2016

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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